BoosterPack Connectors

15 Volt Connector

AFE OUT Connector
Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>ChangeMe!</td>
</tr>
<tr>
<td>002</td>
<td>ChangeMe!</td>
</tr>
</tbody>
</table>

Assembly Notes:

- ZZ1: This Assembly Note is for PCB labels only.
- ZZ2: This Assembly Note will show in the PcbDoc and associated outputs.
- ZZ3: This Assembly Note will show in the PcbDoc and associated outputs.
- ZZ4: This Assembly Note will show in the PcbDoc and associated outputs.

PCB Number: TDA-060001
PCB Rev: A

PCB LOGO
Pb-Free Symbol
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LOGO
PCB
Pb-Free Symbol
LOGO
PCB
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